	Application No.	Applicant(s)	
Notice of Allowability	10/689,958	BASCERI, CEM	
	Examiner	Art Unit	
	Beth E. Owens	2824	
The MAILING DATE of this communication appeal all claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT R	(OR REMAINS) CLOSED or other appropriate comr IGHTS. This application is	in this application. If not included nunication will be mailed in due course	
This communication is responsive to	•		
2. ⊠ The allowed claim(s) is/are <u>1-66</u> .			
3. $igspace$ The drawings filed on <u>22 October 2003</u> are accepted by th	e Examiner.		
 4. ☐ Acknowledgment is made of a claim for foreign priority ur a) ☐ All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents have 2. ☐ Certified copies of the priority documents have 3. ☐ Copies of the certified copies of the priority do International Bureau (PCT Rule 17.2(a)). * Certified copies not received: Applicant has THREE MONTHS FROM THE "MAILING DATE" 	e been received. e been received in Applicat cuments have been receiv	ion No ed in this national stage application fro	
noted below. Failure to timely comply will result in ABANDONN THIS THREE-MONTH PERIOD IS NOT EXTENDABLE. 5. A SUBSTITUTE OATH OR DECLARATION must be subm	.,	KAMINER'S AMENDMENT or NOTICE	: OF
INFORMAL PATENT APPLICATION (PTO-152) which give			. 01
6. CORRECTED DRAWINGS (as "replacement sheets") mus	st be submitted.		
(a) including changes required by the Notice of Draftspers	-	ew (PTO-948) attached	
1) hereto or 2) to Paper No./Mail Date		and the Office antique of	
(b) including changes required by the attached Examiner's Paper No./Mail Date	s Amendment / Comment	or in the Oπice action of	
Identifying indicia such as the application number (see 37 CFR 1 each sheet. Replacement sheet(s) should be labeled as such in t			of
 DEPOSIT OF and/or INFORMATION about the depo attached Examiner's comment regarding REQUIREMENT 			e
Attachment(s) 1. ☑ Notice of References Cited (PTO-892)	5. □ Notice of	Informal Patent Application (PTO-152)	
Notice of Draftperson's Patent Drawing Review (PTO-948)		Summary (PTO-413),	
3. ☑ Information Disclosure Statements (PTO-1449 or PTO/SB/0 Paper No./Mail Date 08302004; 10262004; 1093004	Paper No	o./Mail Dates Amendment/Comment	
4. ☐ Examiner's Comment Regarding Requirement for Deposit	8. 🛭 Examiner	's Statement of Reasons for Allowance	
of Biological Material	9.	MICHAEL S. LEBENTRITT	4
		PRIMARY EXAMINER	

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Information Disclosure Statement

1. It is improper to list U.S. Applications on a PTO-1449 form, as they are not publically available. Accordingly, the references to all U.S. Applications have been removed from the forms submitted 09 November 2004 and 30 August 2004 and this serves as part of the official record that the references were considered by the Examiner.

Examiner's Amendment

2. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to Applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

In the Abstract:

Line 1: replace the first sentence with: --A method of forming a conductive metal silicide by reaction of metal with silicon is described.--

Line 2: replace "In one implementation, such a" with -- A--.

Line 3: replace "comprising" with --with--.

Line 4: replace "silicon containing" with --silicon-containing--.

Line 5: replace "oxide comprising" with --oxide-comprising--.

Line 6: replace "silicon containing" with --silicon-containing--.

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Line 7: replace "Such" with --This ALD-deposited--.

Line 8: replace "metal rich" with --metal-rich--.

Line 9: replace "plasma exposed" with --plasma-exposed--.

Line 11: replace "silicide comprising" with --silicide-comprising--.

In the Claims:

Claims 2-45 and 47-66, line 1: place a comma after "The method of claim X".

Claim 1, line 4: replace "silicon containing" with --silicon-containing--.

Claim 1, line 6: replace "oxide comprising" with --oxide-comprising--.

Claim I, line 6: replace "silicon containing" with --silicon-containing--.

Claim 1, line 10: replace "an" with --a first--.

Claim 1, line 10: replace "metal rich" with --metal-rich--.

Claim 1, line 10: replace "plasma exposed" with --plasma-exposed--.

Claim 1, line 11: insert --said first-- before "metal".

Claim 1, line 11: insert --or metal-rich silicide-- before "of".

Claim 1, line 11: insert --the-- before "elemental".

Claim 1, line 12: replace "silicide comprising" with --silicide-comprising--.

Claim 2, line 2: replace "nitride comprising" with --nitride-comprising--.

Claim 3, line 1: replace "nitride comprising" with --nitride-comprising--.

Claim 4, line 1: replace "nitride comprising" with --nitride-comprising--.

Claim 5, line 2: replace "boride comprising" with --boride-comprising--.

Claim 6, line 1: replace "boride comprising" with --boride-comprising--.

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Claim 7, line 2: replace "carbide comprising" with --carbide-comprising--.

Claim 8, line 1: replace "carbide comprising" with --carbide-comprising--.

Claim 9, line 1: replace "oxide comprising" with --oxide-comprising--.

Claim 10, line 1: replace "oxide comprising" with --oxide-comprising--.

Claim 11, line 1: replace "oxide comprising" with --oxide-comprising--.

Claim 12, line 2: insert --second-- before first use of "metal".

Claim 12, line 2: insert --first-- before second use of "metal".

Claim 13, line 2: insert --second-- before first use of "metal".

Claim 13, line 2: insert --first-- before second use of "metal".

Claim 16, line 1: replace "silicon containing" with --silicon-containing--.

Claim 17, line 1: replace "silicon containing" with --silicon-containing--.

Claim 18, line 2: replace "epitaxially grown" with --epitaxially-grown--.

Claim 21, line 2: replace "of" with --from--.

Claim 22, line 2: replace "of" with --from--.

Claim 23, line 2: insert --said first-- before "elemental".

Claim 24, line 2: insert --said first-- before "elemental".

Claim 25, line 2: replace "metal rich" with --said metal-rich--.

Claim 26, line 2: replace "metal rich" with --said metal-rich--.

Claim 33, line 1: insert a colon after "wherein".

Claim 35, line 2: replace "titanium rich" with --titanium-rich--.

Claim 38, line 2: insert --said first-- before "elemental".

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Claim 39, line 2: replace "metal rich" with --said metal-rich--.

Claim 40, line 1: replace "silicide comprising" with --silicide-comprising--.

Claim 45, line 1: replace "silicon containing" with --silicon-containing--.

Claim 46, line 4: replace "silicon containing" with --silicon-containing--.

Claim 46, line 5: replace "nitride comprising" with --nitride-comprising--.

Claim 46, line 6: replace "silicon containing" with --silicon-containing--.

Claim 46, line 7: replace "nitride comprising" with --nitride-comprising--.

Claim 46, line 9: replace "nitride comprising" with --nitride-comprising--.

Claim 46, line 11: replace "metal rich" with --metal-rich--.

Claim 46, line 12: replace "plasma exposed" with --plasma-exposed--.

Claim 46, line 13: insert --said-- before "metal".

Claim 46, line 13: insert --or metal-rich silicide-- before "of".

Claim 46, line 13: insert --the-- before "elemental".

Claim 46, line 14: replace "silicide comprising" with --silicide-comprising--.

Claim 46, line 15: replace "nitride comprising" with --nitride-comprising--.

Claim 46, line 18: replace "nitride comprising" with --nitride-comprising--.

Claim 47, line 1: replace "nitride comprising" with --nitride-comprising--.

Claim 48, line 1: replace "nitride comprising" with --nitride-comprising--.

Claim 51, line 2: replace "of" with --from--.

Claim 52, line 2: replace "of" with --from--.

Claim 53, line 2: insert --the-- before "elemental".

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Claim 54, line 2: replace "metal rich" with --the metal-rich--.

Claim 59, line 2: replace "nitride comprising" with --nitride-comprising--.

Claim 60, line 1: insert a colon after "wherein".

Claim 61, line 1: replace "silicide comprising" with --silicide-comprising--.

Claim 65, line 2: replace "nitride comprising" with --nitride-comprising--.

Claim 66, line 1: replace "silicon containing" with --silicon-containing--.

3. Authorization for this examiner's amendment was given in a telephone interview with Mark Matkin on November 23, 2004.

Allowance

- 4. Claims 1-66 are allowed.
- 5. The following is an examiner's statement of reasons for allowance:

There is no prior art available nor obvious motivation to combine elements of prior art which teach a method of forming a conductive metal silicide by reaction of metal with silicon, comprising: providing a semiconductor substrate comprising an exposed elemental silicon-containing surface; atomic layer depositing at least one of a nitride, boride, carbide, or oxide-comprising layer onto the exposed elemental silicon-containing surface to a thickness no greater than 15 Angstroms; exposing the layer of thickness no greater than 15 Angstroms to plasma and depositing a conductive reaction layer comprising at least one of a first elemental metal or metal-rich silicide

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and:

onto the plasma-exposed layer; and reacting said first metal or metal-rich silicide of the conductive reaction layer with the elemental silicon of the substrate effective to form a conductive metal silicide-comprising contact region electrically connecting the conductive reaction layer with the substrate;

A method of forming a conductive metal silicide by reaction of metal with silicon, comprising: providing a semiconductor substrate comprising an exposed elemental silicon-containing surface; atomic layer depositing a tantalum nitride-comprising layer onto the exposed elemental siliconcontaining surface to a thickness no greater than 15 Angstroms, the deposited tantalum nitride-comprising layer having a resistance greater than 1000 microohms-cm; exposing the tantalum nitride-comprising layer of thickness no greater than 15 Angstroms to plasma and depositing a conductive reaction layer comprising at least one of an elemental metal or metal-rich silicide onto the plasma-exposed layer; and reacting said metal or metal-rich silicide of the conductive reaction layer with the elemental silicon of the substrate effective to form a conductive metal silicide-comprising contact region over the tantalum nitride-comprising layer which electrically connects the conductive reaction layer with the substrate; the exposing, depositing and reacting being effective to reduce resistance of the tantalum nitride-comprising layer to less than 1000 microohms-cm.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

6. The following prior art, which is considered pertinent to applicant's disclosure although not relied upon, includes "Methods of Forming Capacitors and Integrated Circuit Devices Including Tantalum Nitride" by Choi et al.

Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Beth E. Owens, Ph.D. whose telephone number is 571.272.1882 and fax number for unofficial communications is 571.273.1882.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Richard Elms, can be reached on 571.272.1869. The fax phone number for the organization where this application or proceeding is assigned is 703.872.9306 for official communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 571.272.2800.

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BEO 11.28.04

Qeo

MICHAEL S. LEBENTRITT PRIMARY EXAMINER